Absolute Maximum Ratings (Ta=25℃)

Parameter			Symbol	Rating	Unit
Input	Forward current		I_F	60	mA
	Reverse voltage		V_R	6	V
	Power dissipation		P_D	100	mW
	Derating factor (above T_a = 85°C)			3.8	mW /°C
Output	Off-state Output Terminal Voltage	EL303X	V_{DRM}	250	V
		EL304X		400	
		EL306X		600	
		EL308X		800	
	Peak Repetitive Surge Current (pw=1ms,120pps)		I_{TSM}	1	A
	On-State RMS Current		$I_{T(RMS)}$	100	mA
	Power dissipation		P_C	300	mW
	Derating factor (above T_a = 85°C)			7.6	mW/℃
Total power dissipation			P_{TOT}	330	mW
Isolation voltage *1			V_{ISO}	5000	Vrms
Operating temperature			T_{OPR}	-55 to 100	℃
Storage temperature			T_{STG}	-55 to 125	℃
Soldering Temperature*2			T_{SOL}	260	℃

Notes:
*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2& 3 are shorted together, and pins 4, 5 & 6 are shorted together.
*2 For 10 seconds

Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.*1	Max.	Unit	Condition
Forward Voltage	V_F	-	-	1.5	V	I_F = 30mA
Reverse Leakage current	I_R	-	-	10	μA	V_R = 6V

Output

Parameter		Symbol	Min.	Typ.*	Max.	Unit	Condition
Peak Blocking Current	EL303X EL304X	I_{DRM1}	-	-	100	nA	V_{DRM} = Rated V_{DRM}, I_F = 0 mA*2
	EL306X EL308X				500		
Peak On-state Voltage		V_{TM}	-	-	3	V	I_{TM}=100 mA peak, I_F=Rated I_{FT}
Critical Rate of Rise off-state Voltage	EL303X EL304X EL306X	dv/dt	1000	-	-	V/μs	V_{PEAK} =Rated V_{DRM}, I_F=0 (Fig. 10)*3
	EL308X		600	-	-		
Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)		V_{INH}	-	-	20	V	I_F= Rated I_{FT}
Leakage in Inhibited State		I_{DRM2}	-	-	500	μA	I_F= Rated I_{FT}, V_{DRM}=Rated V_{DRM}, off state

Notes:
*1.Typical values at T_a = 25°C
*2. Test voltage must be applied within dv/dt rating.
*3. This is static dv/dt. See Figure 10 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.

Transfer Characteristics

Parameter		Symbol	Min.	Typ.*	Max.	Unit	Condition
LED Trigger Current	EL3031 EL3041 EL3061 EL3081	I_{FT}	-	-	15	mA	Main terminal Voltage=3V*4
	EL3032 EL3042 EL3062 EL3082		-	-	10		
	EL3033 EL3043 EL3063 EL3083		-	-	5		
Holding Current		I_H	-	280	-	μA	

Notes:
*4. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (15 mA for EL3031/EL3041/EL3061/EL3081,10 mA for EL3032/EL3042/EL3062/EL3082, 5 mA for EL3033/EL3043/EL3063/EL3083) and absolute maximum I_F (60 mA).

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

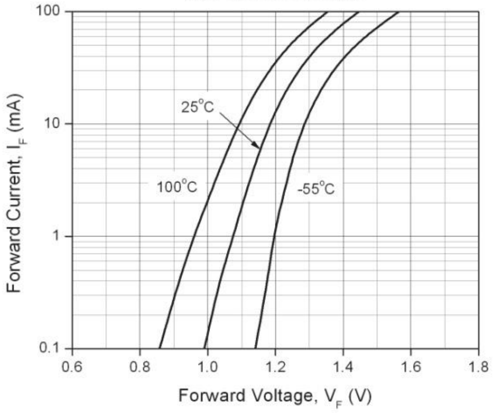


Figure 2. On-State Characteristics

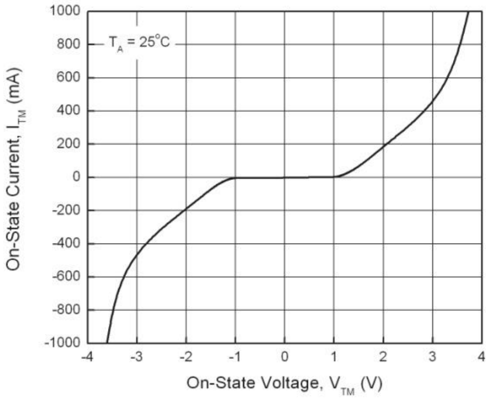


Figure 3. Holding Current vs. Ambient Temperature

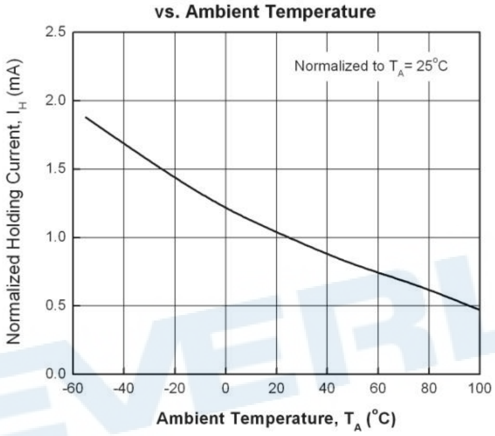


Figure 4. LED Current Required to Trigger vs. LED Pulse Width

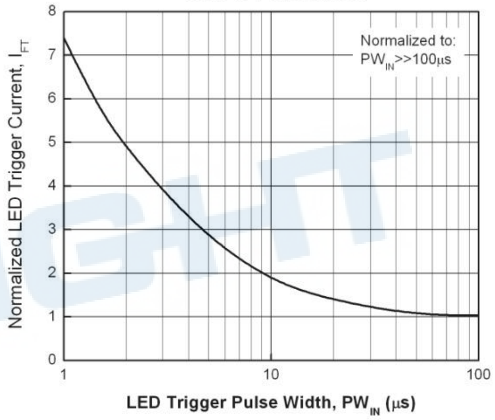


Figure 5. Leakage Current vs. Ambient Temperature

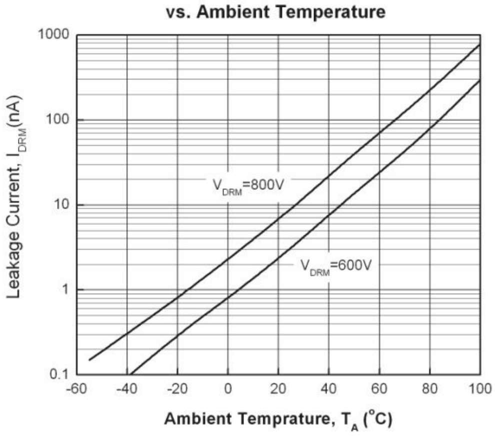


Figure 6. LED Trigger Current vs. Ambient Temperature

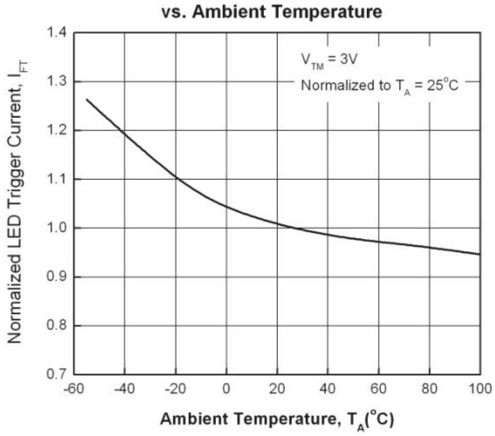


Figure 7. Off-State Output Terminal Voltage vs. Ambient Temperature

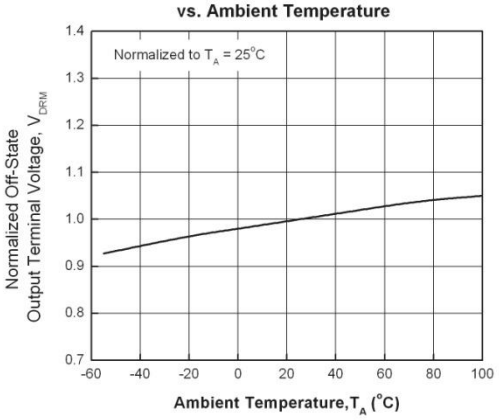


Figure 8. Leakage in Inhibit State vs. Ambient Temperature

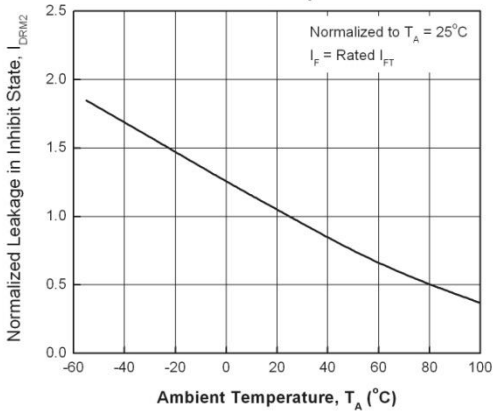


Figure 9. Inhibit Voltage vs. Ambient Temperature

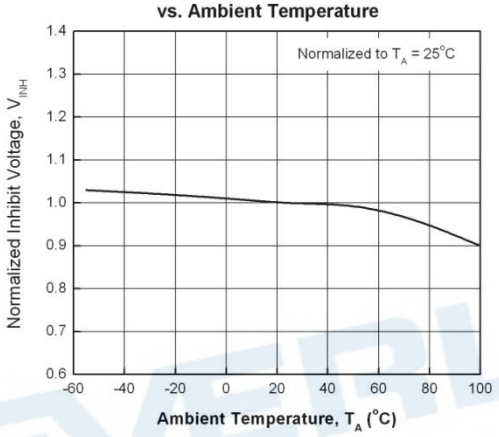
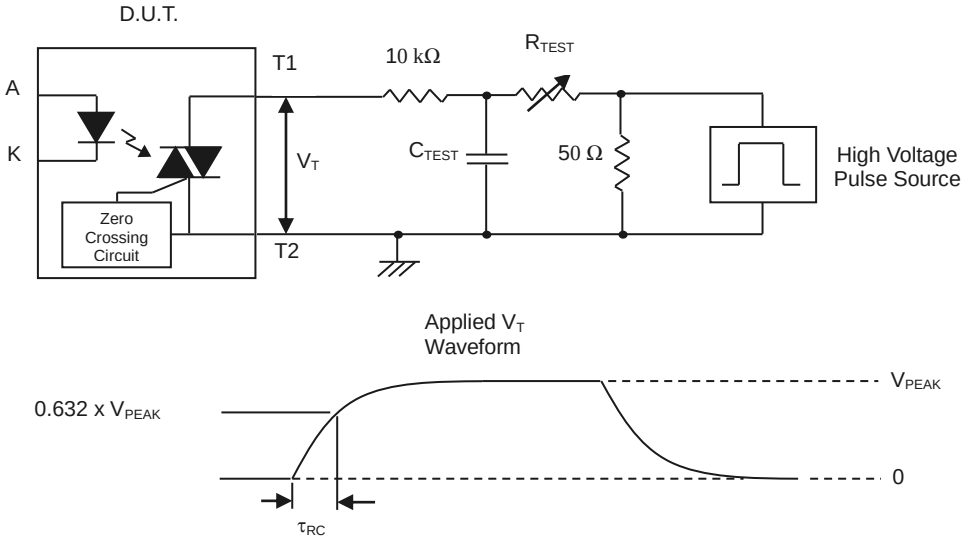


Figure 10. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST}, the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, V_{PEAK} = 600V for EL306X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.632 \times 600}{\tau_{RC}} = \frac{379.2}{\tau_{RC}}$$

Order Information

Part Number

EL303XY(Z)-V
or EL304XY(Z)-V
or EL306XY(Z)-V
or EL308XY(Z)-V

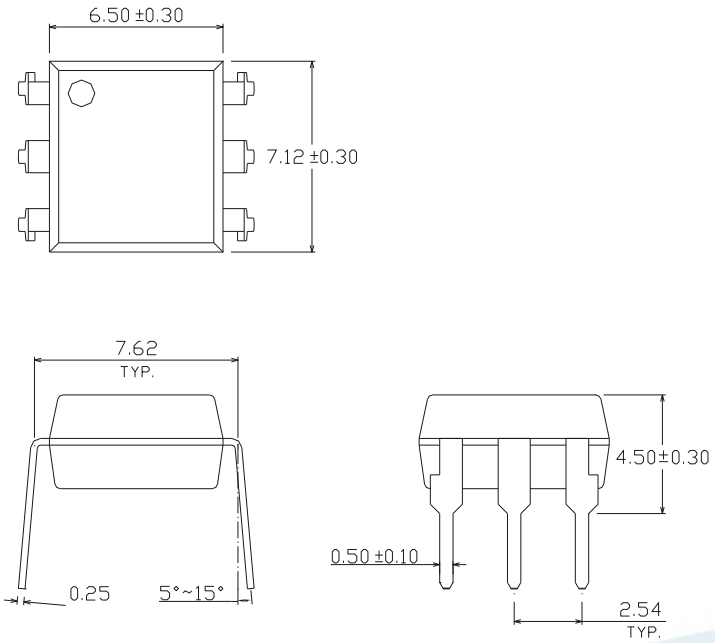
Note

X = Part No. (1, 2 or 3)
Y = Lead form option (S, S1, M or none)
Z = Tape and reel option (TA, TB or none)
V = VDE safety approved option

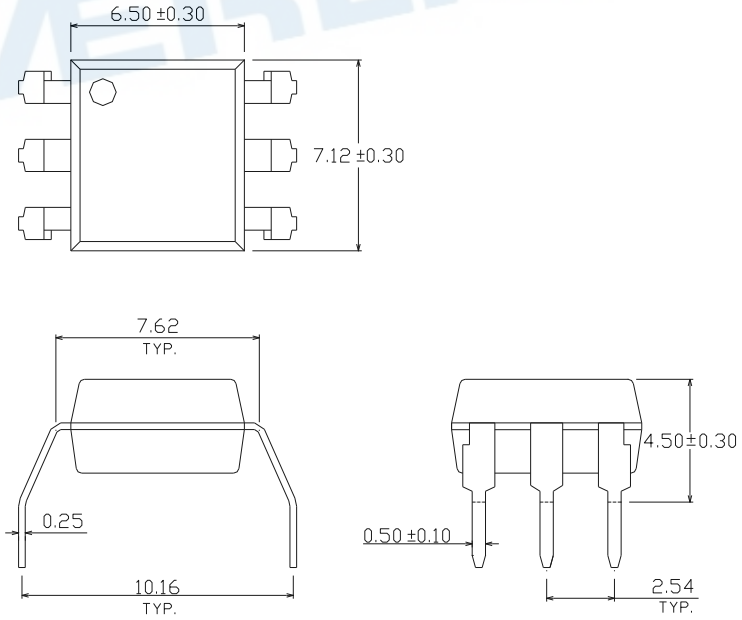
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
M	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

Package Dimension (Dimensions in mm)

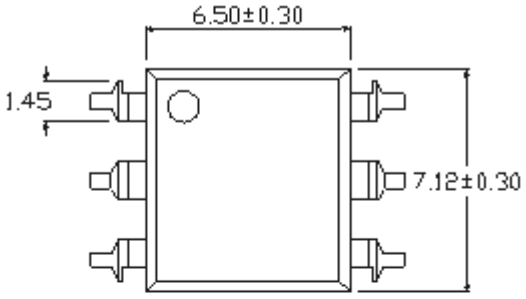
Standard DIP Type

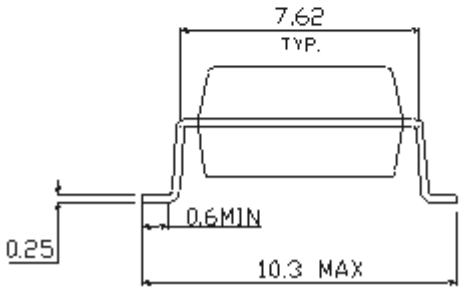


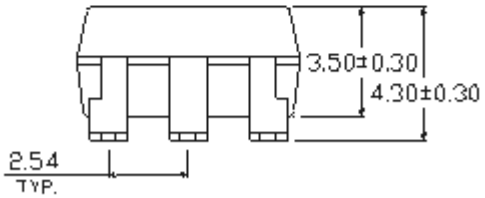
Option M Type



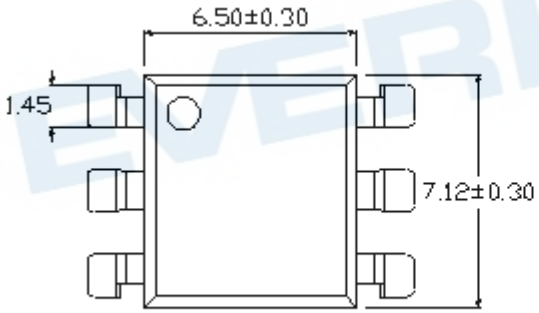
Option S Type

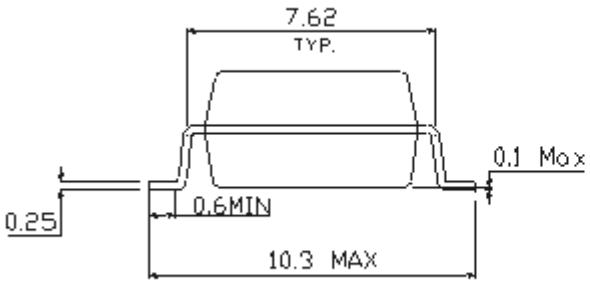


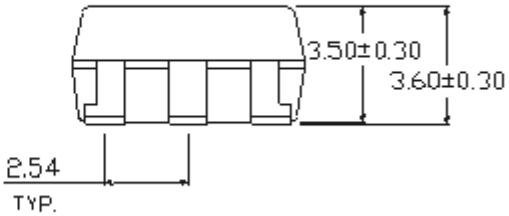




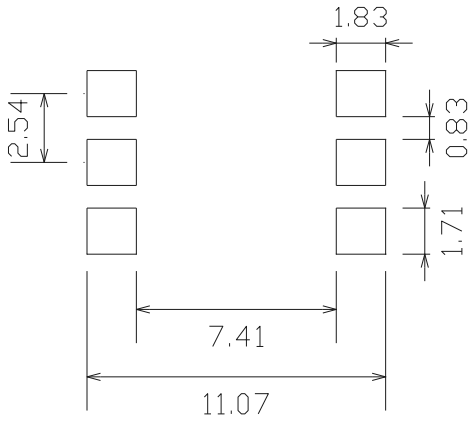
Option S1 Type







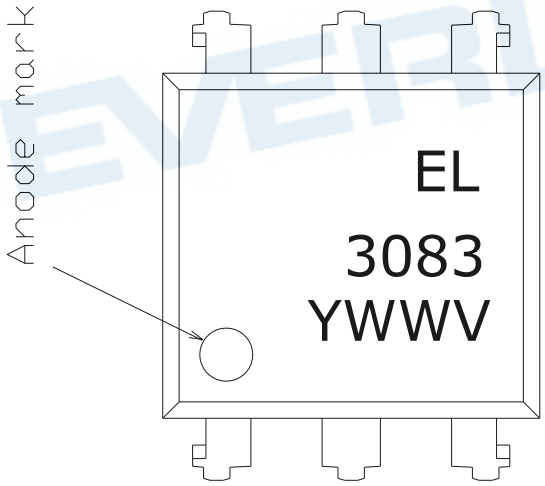
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Device Marking

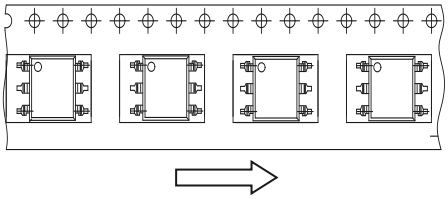


Notes

EL	denotes Everlight
3083	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE option

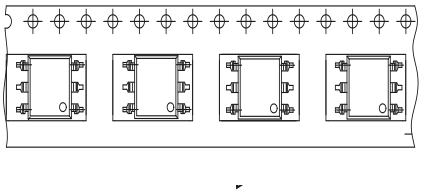
Tape & Reel Packing Specifications

Option TA



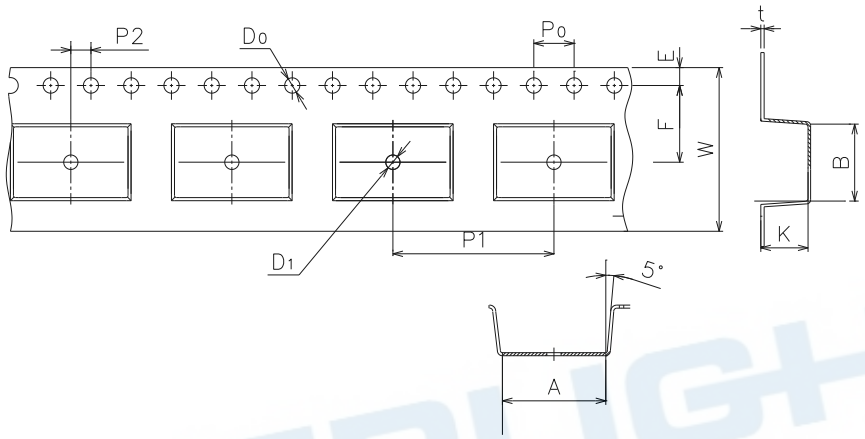
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions



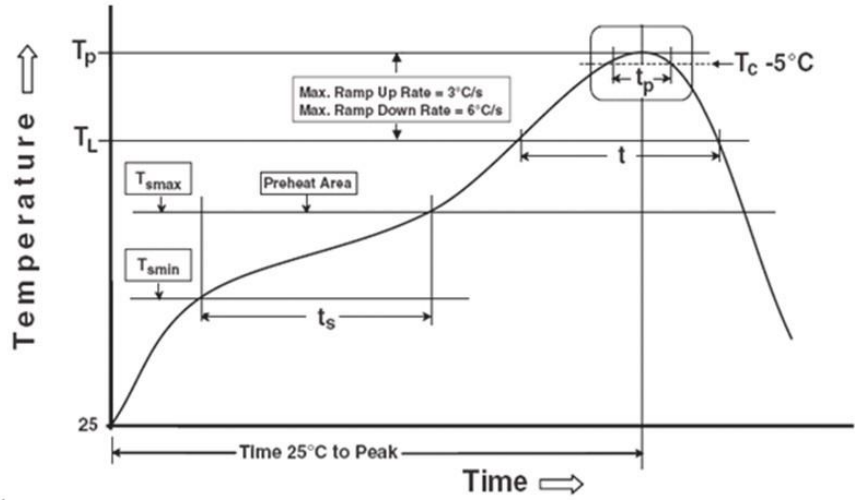
Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	10.8±0.1	7.55±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

.

DISCLAIMER

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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